

A graphene Zener–Klein transistor cooled by a hyperbolic substrate

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The engineering of cooling mechanisms is a bottleneck in nanoelectronics. Thermal exchanges in diffusive graphene are mostly driven by defect-assisted acoustic phonon scattering, but the case of high-mobility graphene on hexagonal boron nitride (hBN) is radically different, with a prominent contribution of remote phonons from the substrate. Bilayer graphene on a hBN transistor with a local gate is driven in a regime where almost perfect current saturation is achieved by compensation of the decrease in the carrier density and Zener–Klein tunnelling (ZKT) at high bias. Using noise thermometry, we show that the ZKT triggers a new cooling pathway due to the emission of hyperbolic phonon polaritons in hBN by out-of-equilibrium electron-hole pairs beyond the super-Planckian regime. The combination of ZKT transport and hyperbolic phonon polariton cooling renders graphene on BN transistors a valuable nanotechnology for power devices and RF electronics.

Energy relaxation in solids is provided by electron–electron interactions and phonon emission. The former give rise to Wiedemann–Franz (WF) heat conduction to the leads. In diffusive graphene, research shows that acoustic phonon emission is dominated by three-body electron–phonon–impurity supercollisions (SCs) at room temperature^{1–4}. The case of high-mobility graphene, in spite of its technological interest, has been investigated less. The suppression of supercollisions and the vanishing of WF heat conduction at current saturation give rise to strongly out-of-equilibrium electron distributions where new cooling pathways become prominent. Intrinsic optical phonon (OP) cooling is one such pathway, and has been reported at high density⁵ and in suspended graphene^{6,7}. Another relaxation mechanism involves interlayer Coulomb coupling in decoupled multilayer epitaxial graphene⁸. In supported graphene, coupling to remote polar phonons overwhelms that to OPs^{9–12}. The case of hBN-supported or -encapsulated graphene is emblematic. First, current saturation can be achieved at low fields E (ref. ¹³), opening access to the Zener–Klein tunnelling (ZKT) regime^{14,15}. Second, hBN is a uniaxial dielectric that sustains hyperbolic phonon-polaritons (HPPs)^{16–22} in the two reststrahlen (RS) bands $\hbar\Omega_1 = 90\text{--}100\text{ meV}$ and $\hbar\Omega_2 = 170\text{--}200\text{ meV}$, where \hbar is the Planck constant and Ω is the HPP pulsation. As a marked difference from SiO₂ surface modes, HPPs can efficiently radiate energy across the dielectric layer¹⁷, avoiding hot-phonon effects and creating an efficient thermal bridge between the graphene channel and the metallic gate in nanodevices.

By means of sensitive noise thermometry, we show strong evidence for a new and ultra-efficient cooling pathway beyond the super-Planckian regime that clips the electron temperature when the ZKT threshold field is reached. This new regime suggests emission of HPPs by out-of-equilibrium electron–hole pairs. We have investigated single-layer (SLG), bilayer (BLG) and

trilayer (TLG) graphene transistors, where similar results are observed (Supplementary Section III and Supplementary Fig. 3). Here, we focus on the BLG sample, which is most illustrative, essentially due to its nearly energy-independent density of states (DOS). (Our investigated energy range ($\pm 200\text{ meV}$) excludes contributions from excited subbands and secures the parabolic band approximation. The gate-induced bandgap opening ($\sim 20\text{ meV}$ at the maximum gate voltage) is null at charge neutrality and small at the scale of the Fermi energy or the electronic temperature at large doping.) In addition, this BLG sample approaches the intrinsic limit with a saturation velocity of $v_{\text{sat}} \approx 3 \times 10^5\text{ m s}^{-1}$, thereby giving more direct insight into the ultimate relaxation mechanisms where currents and Joule power are maximized.

Intraband current saturation

An image of the BLG transistor and its low-bias resistance are presented in Fig. 1a. The device is made of a ($L \times W = 4 \times 3\ \mu\text{m}$) high-mobility ($\mu \approx 3 \times 10^4\text{ cm}^2\text{ V}^{-1}\text{ s}^{-1}$) BLG flake exfoliated on a 23-nm-thick hBN crystal, deposited on a metallic (Au) bottom gate and equipped with high-transparency Pd/Au contacts (see Methods). The gate capacitance $C_{\text{gs}} \approx 1.15\text{ mF m}^{-2}$, calibrated against quantum Hall plateaux, defines the accessible Fermi energy range $\varepsilon_{\text{F}} = \pm 0.2\text{ eV}$. As seen in Fig. 1b, the device demonstrates full current saturation at moderate and high doping, whereas the emergence of a constant-resistance regime at low doping is the fingerprint of ZKT of conductivity σ_{zk} (ref. ¹⁵). As shown in Supplementary Section II and Supplementary Fig. 2, the full current saturation in Fig. 1b results from the balance between the ZKT current and a decrease of the saturation current by drain doping, which is a property of thin dielectric devices. In the following we correct for this effect by biasing the BLG sample along constant density lines ($V_{\text{gs}} - 0.4V_{\text{ds}} = \text{Const.}$). Although similar results are obtained in the electron-doped regime (for the sake of

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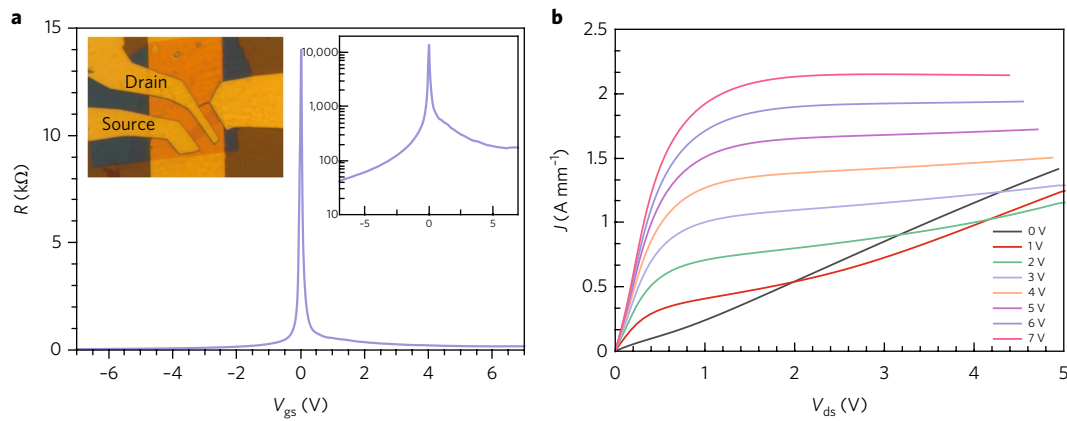


Fig. 1 | Bottom-gated bilayer graphene on hBN transistor (optical image in panel a, inset). a, Low-bias transfer curve $R=1/g_{ds}$ measured at 4.2 K and $V_{ds}=10$ mV. Left inset: Optical image. Right inset: Logarithmic plot showing the small contact resistance in the hole side and a larger one in the electron side due to contact doping. Quantum Hall measurements (not shown) allow the bilayer nature of the sample to be deduced (electronic mobility $\mu \approx 3 \times 10^4$ cm² V⁻¹ s⁻¹ and gate capacitance $C_g = 1.15$ mF m⁻²). The gate capacitance mainly arises from the hBN dielectric capacitance ($\epsilon_r \approx 3.2$) with a negligible serial quantum capacitance correction $C_Q = e^2 \text{DOS} = 2e^2 m^* / (\pi \hbar^2) \approx 40$ mF m⁻² (effective mass $m^* \approx 0.03 m_0$), which defines the accessible Fermi energy range $\epsilon_F = \frac{C_g}{C_Q} e V_g = \pm 0.2$ eV. **b**, Current saturation for different gate voltages in the electron-doped regime (positive bias).

clarity, in the following all the qualitative discussions assume electron doping), we focus on the p-doped regime where the contact resistance is minimized (Fig. 1a, right inset)²³.

Figure 2a presents the full current-bias characteristics, which are consistent with previous investigations^{11–13,24–26}. The length and higher mobility of our sample make it possible to gain a deeper insight into the ZKT regime. At low fields, we observe a strong increase in the intraband current with doping (up to 2 A mm⁻¹ at a hole density of $p = 5 \times 10^{12}$ cm⁻²). Due to the high mobility, the current density rapidly reaches important values and saturates. Figure 2b shows the differential conductance σ at low field, where the ZKT contribution is limited and intraband transport dominates. It obeys a standard $\sigma(E) = \sigma(0)/(1 + E/E_{sat})^2$ dependence¹³ corresponding to a current density $J(E) = J_{sat} E/(E + E_{sat})$ where E_{sat} is the saturation electric field. From the doping dependence of $\sigma(0)$, we extract a finite field mobility $\mu \approx 2.8$ m² V⁻¹ s⁻¹, consistent with the zero field measurement (Fig. 1a). From E_{sat} , sketched as a blue dashed line in Fig. 2b, we define a saturation velocity $v_{sat} = \mu E_{sat} = J_{sat}/ne$ and a saturation energy $\epsilon_{sat} = (\pi/2)\hbar k_F v_{sat}$ (ref. 11), which is plotted in the inset to Fig. 2b. At low doping the saturation energy is limited by the Fermi energy (channel saturation). The saturation of ϵ_{sat} at high doping is generally attributed to OP (or remote phonon) scattering (energy $\hbar\Omega$), according to $\epsilon_{sat} = \hbar\Omega$ (ref. 11). Both the linear increase $\epsilon_{sat} \propto |\epsilon_F|$ and the trend to saturation are observed. We extract the asymptotic limit by fitting the data to the empirical formula $\epsilon_{sat} = (\epsilon_F^{-2} + (\hbar\Omega_{sat})^{-2})^{-1/2}$. We deduce $\hbar\Omega_{sat} \approx 95 \pm 5$ meV, which is consistent with remote phonons $\hbar\Omega_1$ of the lower RS band of hBN.

The ZKT regime. At higher bias, interband (ZKT) transport takes over, leading to a constant differential conductance $\sigma_{zk} \approx 1$ mS. Similar behaviour is observed in SLG and TLG devices (see Supplementary Fig. 3) with $\sigma_{zk}^{SLG} \approx 1.2$ mS and $\sigma_{zk}^{TLG} \approx 2$ mS. In analogy with Klein tunnelling in abrupt p-n junctions in graphene²⁷, ZKT is constrained by energy/momentum conservation¹⁵, which sets a threshold field at $E_{zk} = 2\epsilon_F/(el_{zk})$, where l_{zk} is the doping-dependent tunnelling length. ZKT bears strong analogies with optical pumping as it involves vertical interband transitions (bound by Pauli blocking) with electron-hole pair creation at a rate $\dot{n}_{e-h} = ek_F/(\hbar\pi^2)(\mathcal{E} - \mathcal{E}_{zk})$. As a marked difference, the pumping energy window increases linearly with applied field $E - E_{zk}$. In the absence of a theoretical prediction for BLG ZKT, we rely on

the transmission of a sharp BLG p-n junction²⁷, $D = k_F W/4\pi$ to deduce the ZKT conductance. To account for the finite length of the junction, we introduce a transparency factor $\alpha_{zk} \approx 0.3$ (deduced from the noise measurements, see below). Thus, the ZKT conductance reads $\sigma_{zk} = \alpha_{zk} \frac{4e^2}{h} (k_F l_{zk})/4\pi$. In this simple picture, a doping- and field-independent ZKT conductivity translates into a constant $\alpha_{zk} k_F l_{zk}$ that we deduce from the low-doping data where the ZKT regime is prominent. We are thus able to compute the threshold field $E_{zk} = 2|\epsilon_F|/(el_{zk})$ for each carrier density (red dashed line in Fig. 2a). In the investigated carrier density range we find $l_{zk} \propto k_F^{-1} \gtrsim 0.8$ μm (at $n = 5 \times 10^{12}$ cm⁻²), which is significantly smaller than sample length L . The main outcome of our current-bias analysis is that in quasi-intrinsic samples, intraband current saturation and ZKT have different onset fields (blue and red lines in Fig. 2b), especially at large doping, $|\epsilon_F| = 200$ meV, where $E_{sat} \approx 90$ mV μm^{-1} and $E_{zk} \approx 500$ mV μm^{-1} .

Noise thermometry. Noise thermometry, combined with Joule heating, is a powerful tool to investigate energy relaxation^{28–31}. It relies on the measurement of current noise power density $S_I(f)$ at a frequency large enough to exceed the $1/f$ noise corner frequency, which increases with bias. The noise temperature (equal to the electron temperature in quasi-equilibrium situations) is experimentally defined as $k_B T_N = S_I(L/4\sigma W)$. Technically, we adapted our standard set-up^{29,32,33} to work in the 1–10 GHz band (Supplementary Section I and Supplementary Fig. 1) and accommodated the high-bias conditions. Previous studies have investigated the thermalization sequence in graphene samples with increasing power. This sequence usually starts with WF heat conduction on a limited window in diffusive samples and then displays the signatures of various electron-acoustic phonon coupling mechanisms^{33–35} and the emergence of new mechanisms like SCs^{3,4} or interaction effects with Dirac fluid behaviour at low density³⁶. The bottom line of these studies is the observation of power laws $P_{cool} \propto T_e^\beta$ between cooling power P_{cool} and electronic temperature T_e . Figure 2c shows the very peculiar thermal behaviour of high-mobility graphene on hBN at high power ($P_{heat} \lesssim 2$ GWm⁻²), with an abrupt switching between two cooling mechanisms and the clipping of the electronic temperature at high bias.

The low-bias mechanism is naturally WF cooling, which develops over a wide window due to the large heat conductivity $\kappa \propto \sigma$

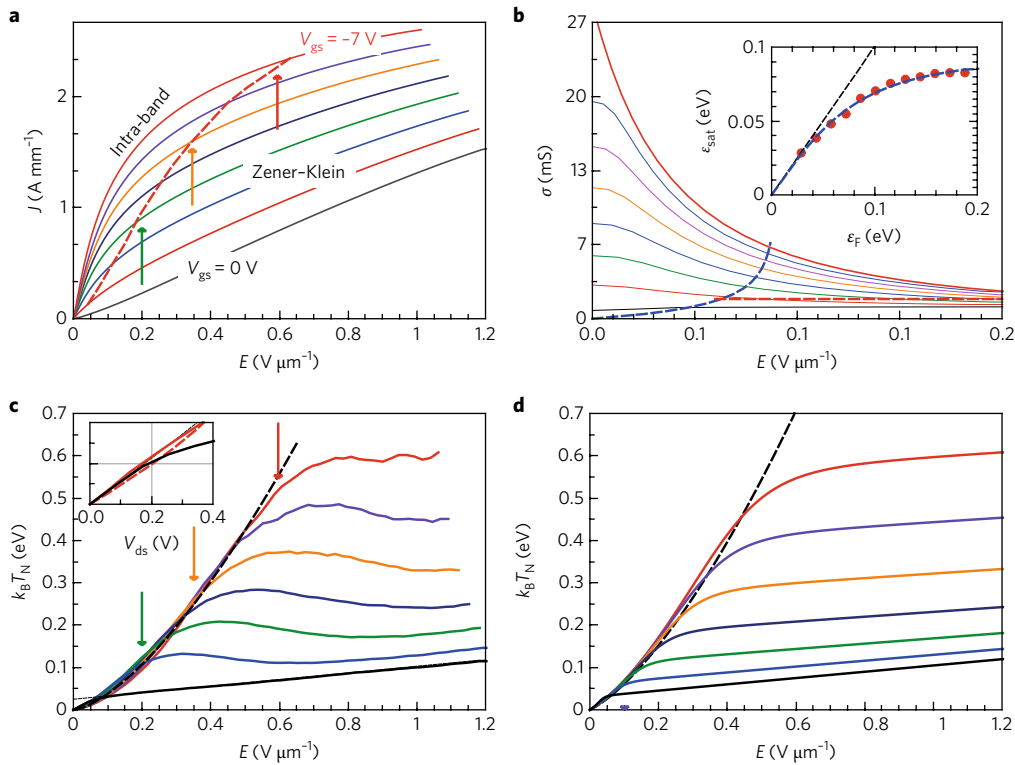


Fig. 2 | Current and noise saturation in bottom-gated bilayer graphene on hBN ZKT transistor. **a**, Nonlinear current-field characteristics of the BLG on hBN transistor in the hole-doped regime. The gate voltage (and hence carrier density and Fermi energy) increases linearly in the range $V_{gs} = [-0, -7]$ V (shown in colours black to red), $p = [0, 5] \times 10^{12}$ cm $^{-2}$ and $|\epsilon_F| = [0, 0.2]$ eV. The onset field for ZKT E_{zk} (see main text) is shown as a red dashed line. **b**, Low-field dependence of the differential conductivity. Blue dashed line: saturation field E_{sat} corresponding to $J = J_{sat}/2$ and $\sigma(E) = \sigma(0)/4$. Note that the ZKT onset field (red dashed line) fulfils $E_{zk}/E_{sat} > 1$. Inset: Fermi energy dependence of saturation energy ϵ_{sat} (defined in the text) and its fitting to $\epsilon_{sat} = (\epsilon_F^{-2} + (\hbar\Omega_{sat})^{-2})^{-1/2}$ with $\hbar\Omega_{sat} = 95 \pm 5$ meV. **c**, Bias field dependence of noise temperature T_N . Two regimes are observed, a steep increase at low field followed by a quasi-saturation above a doping-dependent threshold $V_{on} = E_{on}L$. The transition between the two noise regimes is highlighted by coloured arrows in both **a** and **c**, showing how it matches with the onset of ZKT transport (red dashed line). At zero doping $V_{on} \approx 0.2$ V $\approx \hbar\Omega_{II}$, the HPP phonon energy (inset). **d**, Calculated $k_B T_N(V_{ds})$ plots using the heuristic model described in the text, including WF cooling at low field and out-of-equilibrium HPP emission at high field.

and the absence of SCs in high-mobility graphene. It relies on solutions of the (1D) heat equation $\frac{1}{2}\mathcal{L}\sigma\partial^2 T^2/\partial x^2 = P_j$, where T is the temperature, P_j is the Joule heating density and $\mathcal{L} = (\pi^2 k_B^2)/(3e^2)$ is the Lorenz number. Assuming uniform Joule heating and accounting for cold contacts, one obtains $k_B T_N = \langle k_B T_c \rangle = FL\mathcal{E}$ with the Fano factor $\mathcal{F} = \sqrt{3}$. Experimentally, the temperature shows a superlinear $T_N(V_{ds})$ behaviour (Fig. 2c) that can be explained by the current saturation discussed above and the related decrease in the differential conductance $\sigma(E)$ (Fig. 2b). The $T_N \propto \sqrt{\mathcal{E} \cdot J/\sigma}$ scaling in Fig. 3b confirms the WF nature of the cooling at low bias. Taking $F = 0.1$ (see below) and $E_{sat} = 90$ mV μm^{-1} , we can reproduce the superlinear law with $k_B T_N = FL\mathcal{E}\sqrt{1 + \mathcal{E}/E_{sat}}$ (Fig. 2c,d, dashed lines). Note that $T_N \propto L$ in the WF regime, so smaller temperatures would be observed in shorter samples.

As seen in Fig. 2c, the noise temperature deviates from the WF cooling limit above a doping-dependent onset voltage $V_{on} = LE_{zk}$ and saturates at large electric field (and Joule power), indicating a very efficient cooling mechanism. A crucial difference between the low-bias and high-bias cooling mechanisms lies in their opposite dependence on carrier concentration, as shown in Fig. 3a. The usual observation—the larger the carrier density, the lower the electron temperature—which holds for most cooling mechanisms reported so far (including acoustic phonons, SCs, OPs or WF^{3,37}), breaks down for the high-bias regime. The existence of plateaux, and the increase of the plateau temperature with doping, point to the onset of a new cooling mechanism driven by Pauli blocking

(arrows in Fig. 2a,c). A second hint about this cooling process is given by the lower limit $V_{on} \approx 0.2$ V at neutrality (inset). This feature, also seen in the SLG and TLG noise data (Supplementary Section III and Supplementary Fig. 3), points to an activation energy close to the second RS band of BN, $\hbar\Omega_{II} \approx 0.2$ eV.

Let us first discuss the intrinsic OP relaxation cooling pathway that has been reported in carbon nanotubes^{38,39} and graphene^{7,11}. The question arises especially because the OP energy window ($\hbar\Omega_{OP} = 170$ – 200 meV) is comparable with that of type-II HPPs and can a priori also explain the voltage threshold $V_{on} \approx 0.2$ V at neutrality. The mechanisms are different: instead of a Fröhlich coupling for substrate polar phonons (SPhPs or HPPs), non-polar OPs are coupled to electrons via the deformation potential, giving rise to a smaller relaxation rate. According to theory for thermal emission⁹, the OP cooling power increases with temperature and doping, which is at variance with our observations that cooling increases at temperature saturation (Fig. 2c) or drop down (Supplementary Section IV and Supplementary Fig. 4). Similarly, the OP cooling power increases with doping⁹, which is in conflict with the observed rise in temperature with doping in the ZKT regime at a given Joule power (Fig. 3a). To our knowledge there is no theory for non-thermal emission such as that involved in the Zener–Klein regime. To settle this issue further, we performed an in situ Raman spectroscopy diagnosis of the OP occupation number. This is based on monitoring the Stokes/anti-Stokes G-peaks ratio amplitude as function of bias (Supplementary Section V and

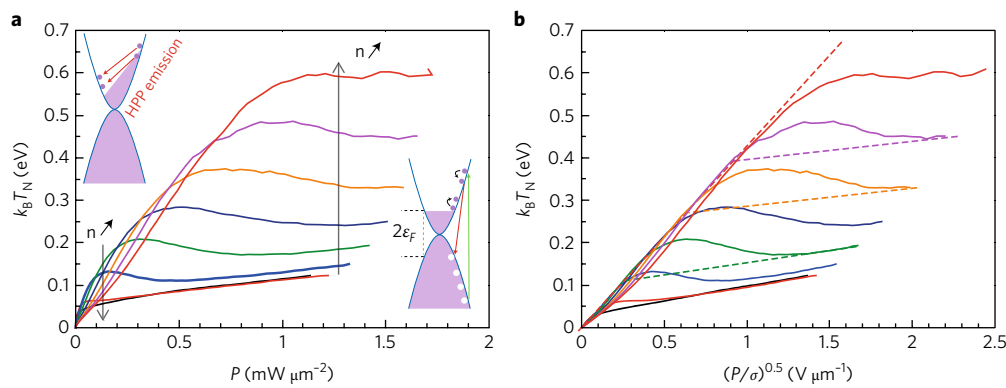


Fig. 3 | Deviation from Wiedemann–Franz cooling. a, Noise temperature as a function of Joule heating. The sketched insets represent the dominating cooling processes: intraband electron–electron interactions at low field and interband HPP emission at high field. Arrows indicate the doping dependence of the noise temperature, which is positive at low field and negative at high field. **b**, WF scaling of the noise temperature data. From the subthreshold slope we deduce the Fano factor $F \approx 0.105$ (red dashed line) and a residual slope $F \approx 0.015$ above the threshold (coloured dashed lines).

Supplementary Fig. 5); the anti-Stokes 2D-peak escapes detection and we assume, following ref. ⁷, an equal contribution of zone edge and zone centre OP cooling. We detect a finite OP population at high electronic temperature, but it is at least four times too small to explain the large cooling powers of our experiments.

Cooling by hyperbolic BN phonon polaritons. In isotropic polar materials, OPs are responsible for an RS band in which light propagation is forbidden. Nevertheless, surface mode polaritons (SPhPs) can develop that create a near-field in the vicinity of the interfaces, to which the electrons of graphene can efficiently couple. The strong uniaxial character of hBN is responsible for the splitting of the RS band into a lower out-of-plane band (90–100 meV) and a higher in-plane band (170–200 meV). In these RS bands, where each mode brings a dielectric function with real parts of opposite signs, the usual evanescent SPhPs are replaced by propagating HPP modes²⁰. The large number of HPP modes (the number of branches equals the number of BN layers) strongly enhances the cooling capability of HPPs compared to SPhPs. Furthermore, while the vertical transport of energy by SPhPs is limited to their evanescent decay length (~ 1 nm in our situation), energy transport by HPPs is only limited by their anharmonic decay, which leads to characteristic depths of ~ 30 nm. In our device, efficient coupling to the hBN layer opens up thermal pathways reaching the gold backgate, where heat is efficiently drained away from the transistor (Fig. 4a, inset).

In this context, heat transfer from the graphene layer to the hBN substrate can be seen as black-body radiation into a material bearing specific hyperbolic modes. In vacuum, black-body radiation in the far-field is strongly constrained by the light cone ($k_{\parallel} \leq k_0 = \omega/c$), which puts severe restrictions on the momentum exchange. This picture has to be revisited when the distance d between the black-body and the dielectric becomes shorter than the thermal wavelength $\lambda_T = \hbar c/k_B T$, reaching the so-called super-Planckian regime where thermal coupling mainly occurs through evanescent modes⁴⁰ up to a wavevector $1/d$. The thermal contact is reached when $d \lesssim \lambda_T$ as the momentum exchange becomes limited by the electron wavevectors.

Real bodies are characterized by their emissivity $M(\omega)$, that is, their relative radiative efficiency compared to black-body emission. Figure 4a represents the experimental average emissivity M of our device as a function of temperature. This emissivity is the ratio of the Joule power to the maximum theoretical super-Planckian radiation power of the BLG on the hBN slab (Supplementary Section VI). If super-Planckian radiation was the main thermal channel, a smoothly decreasing emissivity would be

observed, as calculated in Fig. 4b. In contrast, experimental data show a strong deviation for both the low- and high-temperature sides. The apparently diverging emissivity for $k_B T \lesssim 40$ meV is an artefact due to the increasing contribution of WF cooling at low T . Above $k_B T = 90$ meV, the super-Planckian HPP emissivity becomes significant and scales similarly to WF cooling. This contribution of HPP cooling in the intermediate temperature regime ($40 \text{ meV} < k_B T < E_F$) accounts for the reduced Fano factor $F \approx 0.1$ reported consistently in hBN-supported graphene samples.

The most striking feature in Fig. 4a is a sudden jump of the emissivity at a doping-dependent temperature threshold. This behaviour cannot be understood within a thermal scheme, because the emissivity at fixed doping should only show a smooth dependence on temperature. This dramatic increase of the emissivity by more than a decade shows that an ultra-efficient, strongly out-of-equilibrium process sets in. Interestingly, this new thermal channel arises concomitantly with the switch of the transistor in the ZKT regime (Fig. 2a,b), which is equivalent to an electrical pumping of electron–hole pairs. Thus, we suggest that this thermal channel is due to the emission of HPPs from an inverted electron–hole pair population. In this respect, the threshold voltage ($V_{ds} \approx 0.2$ V) near neutrality shows that electron–hole pairs generated by ZKT with an energy below $\hbar\Omega_{II}$ are naturally unable to cool the sample. Overall, noise thermometry allows us to conclude that beyond a first regime that is most probably thermal, HPP emission above the ZKT onset field is a highly out-of-equilibrium process.

The temperature plateaux observed in Fig. 2c at high doping when cranking up the bias above the ZKT threshold show that the out-of-equilibrium emission of HPPs yields a cooling power P_{HPP} that can compensate the excess Joule power ΔP_J ($\Delta P_J = P_{HPP}$). In the saturation regime, and neglecting the ZKT current with respect to the intraband current, the excess Joule power is given by $\Delta P_J \approx J_{sat}(\mathcal{E} - \mathcal{E}_{zk}) = 2\epsilon_{sat} e k_F / (\pi^2 \hbar) \times (\mathcal{E} - \mathcal{E}_{zk})$, whereas the power drained away by HPP emission is $P_{HPP} = \dot{n}_{e-h} \hbar \Omega_{II}$ with, for electron–hole pairs created by ZKT, $\dot{n}_{e-h} = e k_F / (\hbar \pi^2) (\mathcal{E} - \mathcal{E}_{zk})$. Obviously, those powers equilibrate provided that $2\epsilon_{sat} \approx \hbar \Omega_{II}$, which is roughly the case in hBN because $\epsilon_{sat} \approx \hbar \Omega_I \approx \hbar \Omega_{II} / 2$. Interestingly, this observation shows that in quasi-intrinsic samples, the temperature saturation at high doping ultimately arises from the peculiar frequencies of the hBN RS bands. Taking this effect into account together with the nonlinear WF cooling described above, we plotted in Fig. 2d a simulation of the noise temperature as a function of bias voltage using $\alpha_{zk} = 0.3$ as a free parameters and $F = 0.1$ from the WF scaling in Fig. 3b. The agreement with experiment is good and supports our heuristic model,

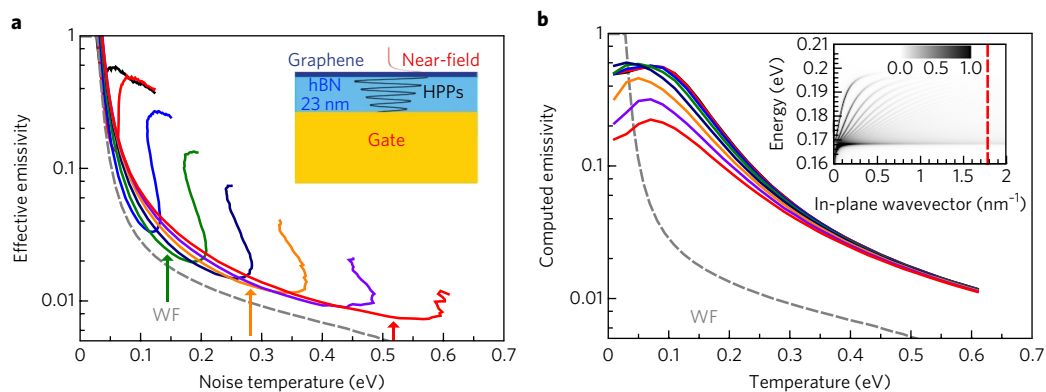


Fig. 4 | HPP emissivity analysis of the noise temperature–Joule power data shown in Fig. 3. **a**, Experimental emissivity computed as the ratio of the Joule power to the theoretical super-Planckian power. Different lines correspond to different gate voltages, with the same colour coding as Figs. 2,3. Inset: Sketch of radiative heat transfer by HPPs. **b**, Theoretical emissivity of the BLG/hBN(23 nm)/Au stack computed as a function of the temperature of the graphene electrons for a BLG in the local conductivity approximation. Inset: Monochromatic emissivity $M(\omega, k)$ of the BLG/hBN/Au stack, showing strong Fabry–Perot-like resonances in the 23-nm-thick hBN layer. Dashed line: wavevector cutoff $k_c(\omega, E_p, T)$ used for calculation of the super-Planckian radiated power. The emissivity of the main panel is the frequency and wavevector average of $M(\omega, k)$ over the whole RS band. Grey dashed lines correspond to the WF cooling regime.

in particular our main hypothesis that HPP cooling can fully compensate Joule heating so that the electronic temperature itself is clipped. Furthermore, we anticipate that in diffusive samples, the lower saturation current (and thus lower Joule power) would lead to a lower equilibrium temperature. Actually, this is observed in a second BLG device with a thicker (200 nm) hBN dielectric (Supplementary Section IV and Supplementary Fig. 4), where a smaller Joule power due to smaller σ_{zk} leads to an imbalance of Joule heating and HPP cooling and a drop in the noise temperature in the ZKT regime.

To characterize further the non-equilibrium HPP emission, it is enlightening to estimate the steady density of electron–hole pairs in the ZKT regime. In fact, for non-thermal electron distributions, the noise temperature T_N has an additional contribution above T_e that is directly related to the presence of non-equilibrium holes. Owing to the constant DOS of BLG, this correction can be captured by splitting the noise temperature integral along the conduction and valence bands and writing, for an electron-doped BLG, $k_B T_N \approx k_B T_e + n_{e-h}/\text{DOS}$ with $k_B T_e \approx \int_0^\infty f(1-f)dE$ and $n_{e-h} = \int_{-\infty}^0 \text{DOS}(1-f)dE$ as $f(E < 0) \lesssim 1$ in weak ZK tunnelling conditions. This correction sets the absolute noise floor for a cold BLG ZKT transistor at $k_B T_N = 2n_{e-h}/\text{DOS}$. In the steady state, the recombination of electron–hole pairs into HPPs at a rate $\dot{n}_{e-h} = -n_{e-h}/\tau$ (where τ is an effective HPP emission time) just equilibrates electron–hole generation by ZKT. We thus obtain $n_{e-h} = 2\tau\sigma_{zk}/el_{zk} \times (E - E_{zk})$ consistent with the residual linear dependence $T_N(E)$ observed in the low-doping limit where the ZKT regime is most developed (Fig. 2c). The slope of $T_N(E)$ near neutrality yields $\tau \approx 0.5$ ps, approaching the minimum emission time of ~ 0.13 ps (Supplementary Section VI). Note that the measured time τ is much larger than the intraband electron–electron relaxation time (~ 50 fs)^{41,42} but roughly four times smaller than the intrinsic OP emission time entering the cooling rate⁹. This analysis provides a consistent picture of the cooling pathway where electrons in the conduction band rapidly thermalize with the Fermi sea, whereas intrinsic energy relaxation by OPs is quenched by a faster coupling to HPPs. We note that fast HPP relaxation has been recently reported in a photo-thermoelectric photovoltage experiment⁴³.

Conclusion

In conclusion, using combined transport and noise thermometry, we have shown that quasi-intrinsic bilayer graphene on hBN transistors have remarkable thermal properties, dominated by

WF conduction and hBN HPP emission. In particular, we have unveiled a new out-of-equilibrium HPP emission process subsequent to the generation of electron–hole pairs by ZKT, which yields the temperature plateaux observed at high doping. A direct signature of this non-equilibrium hole population is observable as a linear correction to the electronic temperature in the noise power in the low-doping limit from which we estimate an HPP relaxation time of ~ 0.5 ps. This graphene-on-BN technology based on local gating of high-mobility graphene through a thin hBN layer opens up many perspectives. For applications it comprises a promising platform for radiofrequency power amplification and for the design of original cooling pathways in nanodevices. For basic science it opens up the study of cold cooling pathways involving out-of-equilibrium carriers generated by tunnelling processes, and promotes graphene as a dedicated source for HPP optics.

Methods

Methods, including statements of data availability and any associated accession codes and references, are available at <https://doi.org/10.1038/s41565-017-0007-9>.

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Author contributions

W.Y., E.B., C.V. and B.P. conceived the experiment and developed the models. W.Y. and S.B. conducted the measurements. A.D. designed the sample holder. W.Y., X.L., M.R., T.T., K.W., Q.W. and G.Z. participated in sample fabrication. W.Y., S.B., G.F., J.-M.B., E.B., C.V. and B.P. participated in data analysis. W.Y., E.B., C.V. and B.P. wrote the manuscript with contributions from the coauthors.

Competing interests

The authors declare no competing financial interests.

Additional information

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Methods

The graphene boron nitride heterostructures (including monolayer, bilayer and trilayer graphene) were assembled using the dry transfer technique⁴⁴ and the devices were fabricated by electron-beam lithography. We first deposited the bottom gate (width 15 μm) and coplanar waveguide using 2/50 nm Cr/Au metallization on a high-resistivity Si substrate covered by a 285 nm SiO_2 . A high-quality hBN crystal was then stamped on top of the gate under a microscope. The polydimethylsiloxane stamp was removed with acetone and the sample was cleaned further by 1–2 h annealing at a temperature of 300–400 °C under 200 s.c.c.m. Ar/50 s.c.c.m. H_2 flow. The exfoliated graphene flakes were transferred onto the hBN using a polypropylene carbonate stamp, removed again with acetone and annealed as before. Graphene remained as exfoliated to

avoid degrading mobility etching processes. Finally 50/50 nm Pd/Au source and drain contacts were deposited. Our devices were uncapped to secure low contact resistance at high frequency and bias. Chemical surface contamination was removed in situ by current annealing at low temperature.

Data availability. The data that support the plots within this paper and other findings of this study are available from the corresponding author upon reasonable request.

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